

# **VSP2101**

# **Speed** CCD SIGNAL PROCESSOR For Digital Cameras

### **FEATURES**

- CCD SIGNAL PROCESSING: Correlated Double Sampling Black Level Clamping
   -2 to +34dB Gain Ranging High SNR: 53dB
- 10-BIT A/D CONVERSION:
   Up to 27MHz Conversion Rate
   No Missing Codes
- PORTABLE OPERATION:
   Low Voltage: 2.7V to 3.6V
   Low Power: 190mW at 3.0V
   LOW POWER: 160mW at 2.7V
   POWER-DOWN MODE: 18mW

## **APPLICATIONS**

- VIDEO CAMERAS
- DIGITAL STILL CAMERAS
- PC CAMERAS
- SECURITY CAMERAS

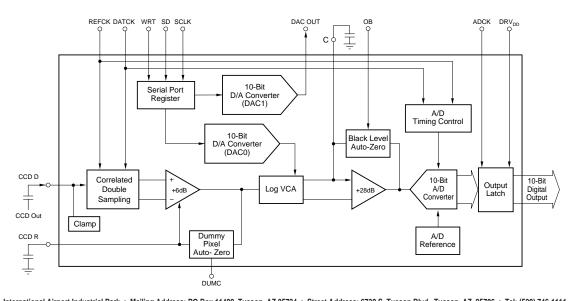
## DESCRIPTION

The VSP2101Y is a complete digital camera IC, providing signal conditioning and 10-bit analog-to-digital conversion for the output of a CCD array.

The primary CCD channel provides correlated double sampling to extract the video information from the pixels, -2dB to +34dB gain ranging with digital control for varying illumination conditions, and black level clamping for an accurate black reference.

Input signal clamping and offset correction of the CDS is also performed. The stable gain control is linear in dB. Additionally, the black level is quickly recovered after gain change. An on-chip general purpose 10-bit digital-to-analog converter allows you to obtain analog control voltage for iris control.

The VSP2101Y is available in a 48-lead LQFP package and operates from a single +3V supply.



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#### PACKAGING INFORMATION

| Orderable part number | Status   | Material type | Package   Pins | Package qty   Carrier | RoHS | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|----------|---------------|----------------|-----------------------|------|-------------------------------|----------------------------|--------------|------------------|
|                       |          |               |                |                       |      | (4)                           | (5)                        |              |                  |
| VSP2101Y              | Obsolete | Production    | LQFP (PT)   48 | -                     | -    | Call TI                       | Call TI                    | -25 to 85    | VSP2101Y         |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

- (3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.
- (4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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